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Part Number:

0751170118

Status:

Active

Overview:

VHDM® Backplane Connector Systems

Description:

VHDM® Single-Ended Board-to-Board Stacker Receptacle, 2.00mm Pitch, Vertical, 8-Rows, 80 Circuits, 0.76µm Gold (Au)

Documents:

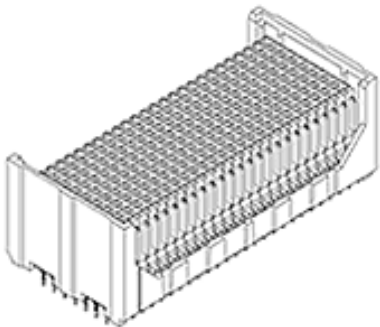
3D Model

Drawing (PDF)

Product Specification PS-74031-999 (PDF)

RoHS Certificate of Compliance (PDF)

General	
Product Family	Backplane Connectors
Series	75117
Application	Board-to-Board Mezzanine
Application Tooling Documents	TM-622010999
Comments	Stack Height 18.00mm, Lead-Free
Component Type	PCB Receptacle
Overview	VHDM® Backplane Connector Systems
Product Name	VHDM®
UPC	756054905852
Physical	
Circuits (Loaded)	80
Circuits (maximum)	80
Color - Resin	Black
Durability (mating cycles max)	200
First Mate / Last Break	No
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Copper-Nickel-Silicon, High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Matte Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	13.060/g
Number of Columns	10
Number of Pairs	Open Pin Field
Number of Rows	8
Orientation	Vertical
PC Tail Length	2.85mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.80mm
Packaging Type	Tube
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	1.00mm
Plating min - Mating	0.762µm
Plating min - Termination	0.762µm
Polarized to PCB	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin
Electrical	
Current - Maximum per Contact	3.0A
Data Rate	3.125 Gbps
Voltage - Maximum	120V AC (RMS)/DC



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

China RoHS

Compliant

REACH SVHC

Not Contained Per

-ED/79/2015 (17

December 2015)

Halogen-Free

Status

Low-Halogen

Need more information on product

environmental compliance?

Email productcompliance@molex.com

Please visit the [Contact Us](#) section for any

non-product compliance questions.

China ROHS

Green Image

ELV

Not Relevant

Search Parts in this Series

75117 Series

Mates With

74060 VHDM® Board-to-Board Backplane

Header

Application Tooling | FAQ

Tooling specifications and manuals are

found by selecting the products below.

Crimp Height Specifications are then

contained in the Application Tooling

Specification document.

Global

Description

Product #

Single Wafer

0622021450

Removal Tool, 8-

Row

Solder Process Data

Lead-free	Process Capability	N/A
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Material Info

Reference - Drawing Numbers

Product Specification	PS-74031-999
Sales Drawing	SD-75117-001

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